MCP7H60-W002R26-C

Mellanox® MCP7H60-W002R26 Compatible TAA 400GBase-CU QSFP-DD 400G to 2xQSFP56 200G PAM-4 Direct Attach Cable (Passive Twinax, 2m)

Features:

- Compliant to QSFP-DD MSA Standards
- QSFP Module Compliant to SFF-8661
- Transmission Data Rate up to 56Gbps Per Channel
- Enables 400Gbps to 2x200Gbps Transmission
- Built-In EEPROM functions
- Hot-Pluggable
- Operating Temperature: 0 to 70 Celsius
- RoHS Compliant and Lead-Free

Applications:

- 400GBase Ethernet

Product Description

This is a Mellanox® MCP7H60-W002R26 Compatible 400GBase-CU QSFP-DD to 2xQSFP56 direct attach cable that operates over passive copper with a maximum reach of 2m. It has been programmed, uniquely serialized, and data-traffic and application tested to ensure it is 100% compliant and functional. We stand behind the quality of our products and proudly offer a limited lifetime warranty. This cable is TAA (Trade Agreements Act) compliant and is built to comply with MSA (Multi-Source Agreement) standards.

ProLabs' transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S. – made or designated country end products."

Rev. 030425

General Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit
Storage Temperature	Tstg	-40		85	°C
Operating Case Temperature	Tc	0		70	°C
Supply Voltage	Vcc	3.13	3.3	3.47	V
Relative Operating Humidity	RH	5		85	%
Data Rate	DR		400		Gbps

Physical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Length	L			2	M	
AWG			30		AWG	
Jacket Material			PVC, Black			

Electrical Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Resistance	Rcon			3	Ω	
Insulation Resistance	Rins			10	MΩ	
Raw Cable Impedance	Zca	95		110	Ω	
Mated Connector Impedance	Zmated	85		110	Ω	
Maximum Insertion Loss @13.28GHz	SDD21	8		17.16	dB	
Differential to Common-Mode Return Loss	SDD11/ 22	$RLcd(f) \geq \begin{cases} 22 - (20/25.78)f & 0.01 \leq f < 12.89 \\ 15 - (6/25.78)f & 12.89 \leq f \leq 19 \end{cases}$			dB	
Differential to Common-Mode Conversion Loss	SCD21-SDD21	$Conversion\_loss(f) - IL(f) \geq \begin{cases} 10 & 0.01 \leq f < 12.89 \\ 27 - (29/22)f & 12.89 \leq f \leq 15.7 \\ 6.3 & 15.7 \leq f \leq 19 \end{cases}$			dB	
Minimum COM	COM	3			dB	

Pin Descriptions for QSFP-DD

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1B	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3B	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3B	
4		GND	Module Ground.	1B	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3B	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3B	
7		GND	Module Ground.	1B	1
8	LVTTL-I	ModSelL	Module Select.	3B	
9	LVTTL-I	ResetL	Module Reset.	3B	
10		VccRx	+3.3V Receiver Power Supply.	2B	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3B	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3B	
13		GND	Module Ground.	1B	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3B	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3B	
16		GND	Module Ground.	1B	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3B	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3B	
19		GND	Module Ground.	1B	1
20		GND	Module Ground.	1B	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3B	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3B	
23		GND	Module Ground.	1B	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3B	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3B	
26		GND	Module Ground.	1B	1
27	LVTTL-O	ModPrsL	Module Present.	3B	
28	LVTTL-O	IntL	Interrupt.	3B	
29		VccTx	+3.3V Transmitter Power Supply.	2B	2
30		Vcc1	+3.3V Power Supply.	2B	2
31	LVTTL-I	InitMode	Initialization Mode. In legacy QSFP applications, the InitMode pad is called LPMODE.	3B	
32		GND	Module Ground.	1B	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3B	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3B	
35		GND	Module Ground.	1B	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3B	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3B	
38		GND	Module Ground.	1B	1
39		GND	Module Ground.	1A	1
40	CML-I	Tx6-	Transmitter Inverted Data Input.	3A	

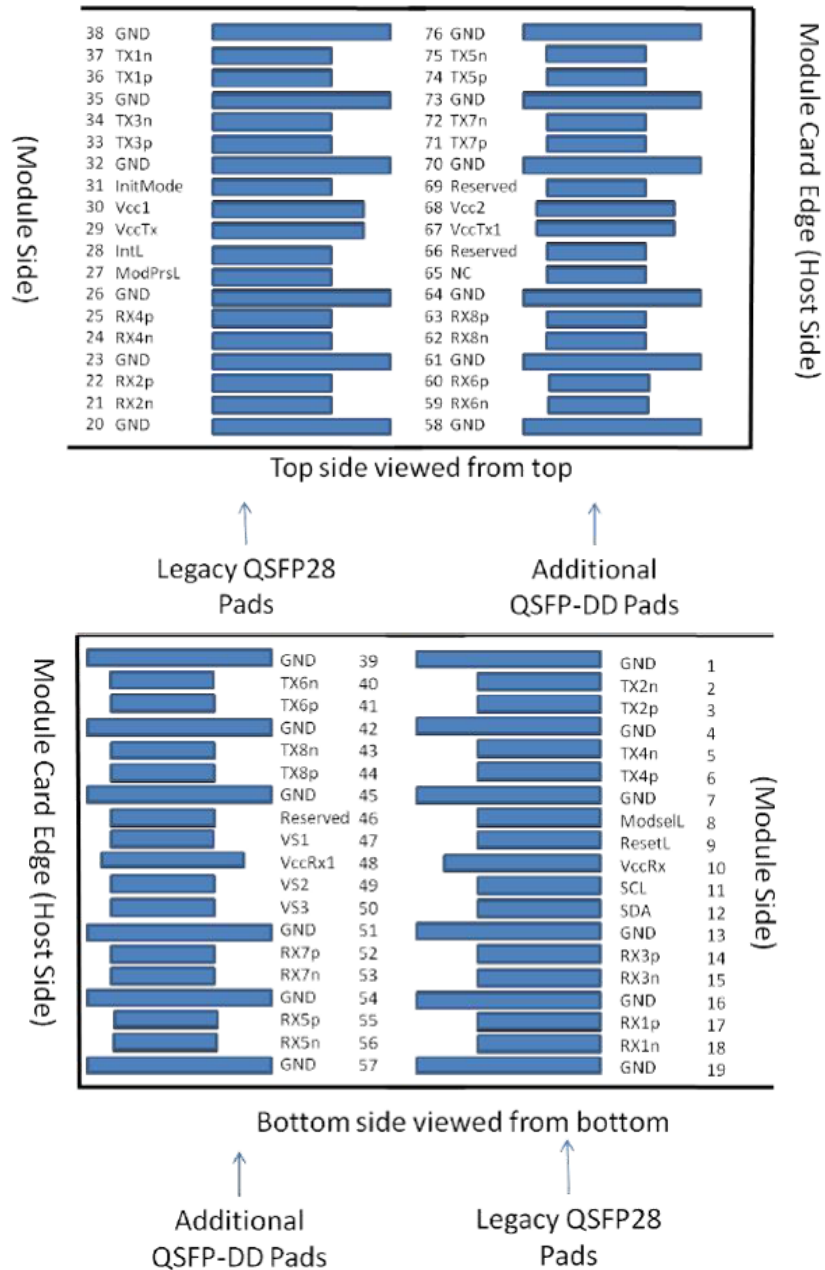| 41	CML-I	Tx6+	Transmitter Non-Inverted Data Input.	3A	
42		GND	Module Ground.	1A	1
43	CML-I	Tx8-	Transmitter Inverted Data Input.	3A	
44	CML-I	Tx8+	Transmitter Non-Inverted Data Input.	3A	
45		GND	Module Ground.	1A	1
46		Reserved	For Future Use.	3A	3
47		VS1	Module Vendor-Specific 1.	3A	3
48		VccRx1	+3.3V Receiver Power Supply.	2A	2
49		VS2	Module Vendor-Specific 2.	3A	3
50		VS3	Module Vendor-Specific 3.	3A	3
51		GND	Module Ground.	1A	1
52	CML-O	Rx7+	Receiver Non-Inverted Data Output.	3A	
53	CML-O	Rx7-	Receiver Inverted Data Output.	3A	
54		GND	Module Ground.	1A	1
55	CML-O	Rx5+	Receiver Non-Inverted Data Output.	3A	
56	CML-O	Rx5-	Receiver Inverted Data Output.	3A	
57		GND	Module Ground.	1A	1
58		GND	Module Ground.	1A	1
59	CML-O	Rx6-	Receiver Inverted Data Output.	3A	
60	CML-O	Rx6+	Receiver Non-Inverted Data Output.	3A	
61		GND	Module Ground.	1A	1
62	CML-O	Rx8-	Receiver Inverted Data Output.	3A	
63	CML-O	Rx8+	Receiver Non-Inverted Data Output.	3A	
64		GND	Module Ground.	1A	1
65		NC	Not Connected.	3A	3
66		Reserved	For Future Use.	3A	3
67		VccTx1	+3.3V Transmitter Power Supply.	2A	2
68		Vcc2	+3.3V Power Supply.	2A	2
69		Reserved	For Future Use.	3A	3
70		GND	Module Ground.	1A	1
71	CML-I	Tx7+	Transmitter Non-Inverted Data Input.	3A	
72	CML-I	Tx7-	Transmitter Inverted Data Input.	3A	
73		GND	Module Ground.	1A	1
74	CML-I	Tx5+	Transmitter Non-Inverted Data Input.	3A	
75	CML-I	Tx5-	Transmitter Inverted Data Input.	3A	
76		GND	Module Ground.	1A	1

Notes:
1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 shall be applied concurrently. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 may be internally connected within the module in any combination. The connector Vcc

pins are each rated for a maximum current of 1000mA.

3. All Vendor-Specific, Reserved, and Not Connected pins may be terminated with 50Ω to ground on the host. Pad 65 (Not Connected) shall be left unconnected within the module. Vendor-Specific and Reserved pads shall have an impedance to GND that is greater than 10kΩ and less than 100pF.

4. Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1A, 2A, 3A, 1B, 2B, and 3B. Contact sequence A will make, then break contact with additional QSFP-DD pads. Sequence 1A, 1B will then occur simultaneously, followed by 2A, 2B, followed by 3A, 3B.
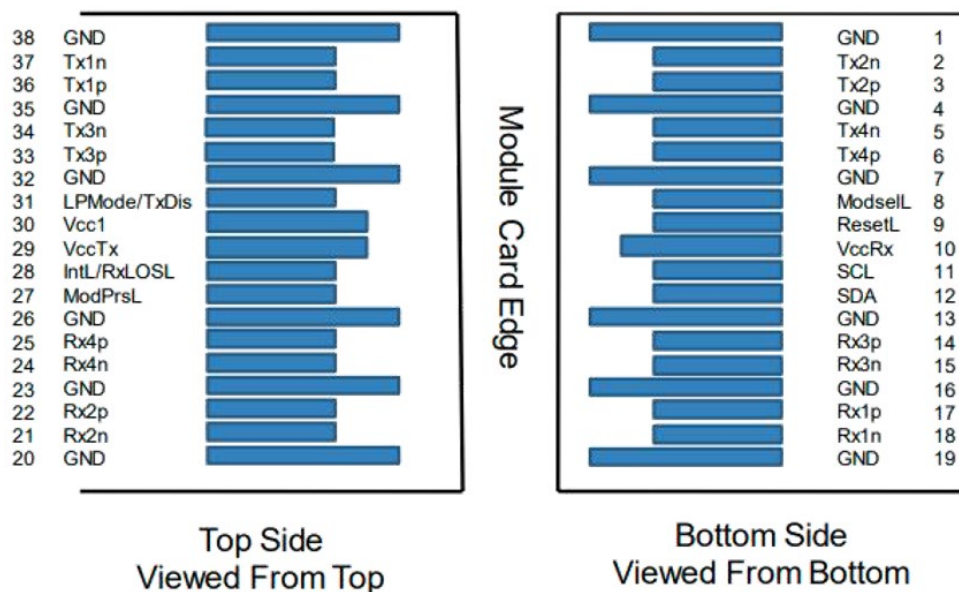
Electrical Pin-Out Details for QSFP-DD

(Module Side)

38	GND
37	TX1n
36	TX1p
35	GND
34	TX3n
33	TX3p
32	GND
31	InitMode
30	Vcc1
29	VccTx
28	IntL
27	ModPrsL
26	GND
25	RX4p
24	RX4n
23	GND
22	RX2p
21	RX2n
20	GND

76	GND
75	TX5n
74	TX5p
73	GND
72	TX7n
71	TX7p
70	GND
69	Reserved
68	Vcc2
67	VccTx1
66	Reserved
65	NC
64	GND
63	RX8p
62	RX8n
61	GND
60	RX6p
59	RX6n
58	GND

Module Card Edge (Host Side)

Top side viewed from top

Legacy QSFP28 Pads

Additional QSFP-DD Pads

Module Card Edge (Host Side)

GND	39
TX6n	40
TX6p	41
GND	42
TX8n	43
TX8p	44
GND	45
Reserved	46
VS1	47
VccRx1	48
VS2	49
VS3	50
GND	51
RX7p	52
RX7n	53
GND	54
RX5p	55
RX5n	56
GND	57

GND	1
TX2n	2
TX2p	3
GND	4
TX4n	5
TX4p	6
GND	7
ModselL	8
ResetL	9
VccRx	10
SCL	11
SDA	12
GND	13
RX3p	14
RX3n	15
GND	16
RX1p	17
RX1n	18
GND	19

(Module Side)

Bottom side viewed from bottom

Additional QSFP-DD Pads

Legacy QSFP28 Pads

Pin Descriptions for QSFP

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3	
4		GND	Module Ground.	1	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3	
7		GND	Module Ground.	1	1
8	LVTTL-I	ModSelL	Module Select.	3	
9	LVTTL-I	ResetL	Module Reset.	3	
10		VccRx	+3.3V Receiver Power Supply.	2	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3	
13		GND	Module Ground.	1	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3	
16		GND	Module Ground.	1	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3	
19		GND	Module Ground.	1	1
20		GND	Module Ground.	1	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3	
23		GND	Module Ground.	1	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3	
26		GND	Module Ground.	1	1
27	LVTTL-O	ModPrsL	Module Present.	3	
28	LVTTL-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636).	3	
29		VccTx	+3.3V Transmitter Power Supply.	2	2
30		Vcc1	+3.3V Power Supply.	2	2
31	LVTTL-I	LPMode/TxDis	Low-Power Mode. Optionally configurable as TxDis via the management interface (SFF-8636).	3	
32		GND	Module Ground.	1	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3	

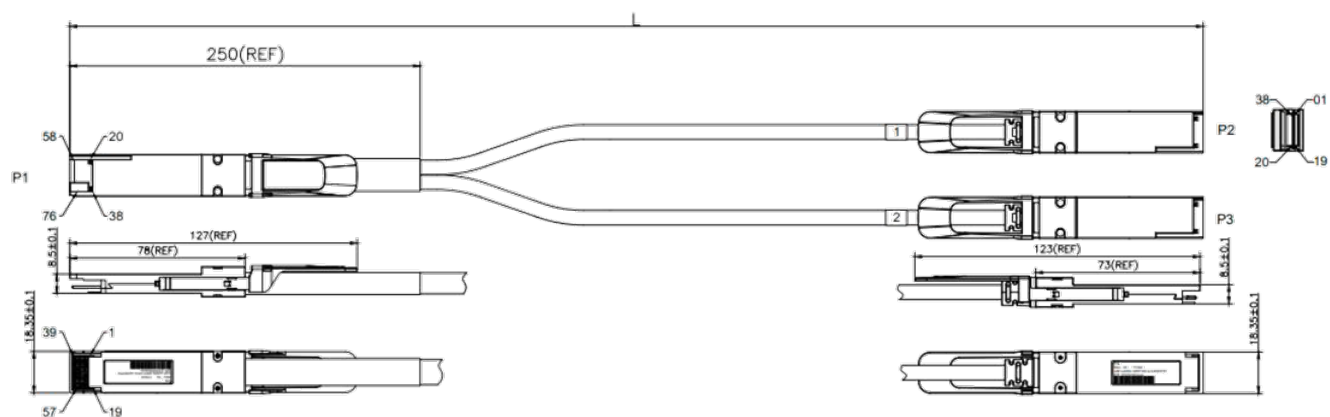| 34 | CML-I | Tx3- | Transmitter Inverted Data Input. | 3 | |
35		GND	Module Ground.	1	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3	
38		GND	Module Ground.	1	1

Notes:

1. GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, Vcc1, and VccTx are the receiver and transmitter power supplies and shall be applied concurrently. VccRx, Vcc1, and VccTx may be internally connected within the QSFP transceiver module in any combination. The connector pins are each rated for a maximum current of 500mA.

Electrical Pin-Out Details for QSFP

38	GND
37	Tx1n
36	Tx1p
35	GND
34	Tx3n
33	Tx3p
32	GND
31	LPMode/TxDis
30	Vcc1
29	VccTx
28	IntL/RxLOSL
27	ModPrsL
26	GND
25	Rx4p
24	Rx4n
23	GND
22	Rx2p
21	Rx2n
20	GND

Top Side
Viewed From Top

Module Card Edge

GND	1
Tx2n	2
Tx2p	3
GND	4
Tx4n	5
Tx4p	6
GND	7
ModselL	8
ResetL	9
VccRx	10
SCL	11
SDA	12
GND	13
Rx3p	14
Rx3n	15
GND	16
Rx1p	17
Rx1n	18
GND	19

Bottom Side
Viewed From Bottom

Mechanical Specifications

About ProLabs

Our experience comes as standard; for over 15 years ProLabs has delivered optical connectivity solutions that give our customers freedom and choice through our ability to provide seamless interoperability. At the heart of our company is the ability to provide state-of-the-art optical transport and connectivity solutions that are compatible with over 90 optical switching and transport platforms.

Complete Portfolio of Network Solutions

ProLabs is focused on innovations in optical transport and connectivity. The combination of our knowledge of optics and networking equipment enables ProLabs to be your single source for optical transport and connectivity solutions from 100Mb to 400G while providing innovative solutions that increase network efficiency. We provide the optical connectivity expertise that is compatible with and enhances your switching and transport equipment.

Trusted Partner

Customer service is our number one value. ProLabs has invested in people, labs and manufacturing capacity to ensure that you get immediate answers to your questions and compatible product when needed. With Engineering and Manufacturing offices in the U.K. and U.S. augmented by field offices throughout the U.S., U.K. and Asia, ProLabs is able to be our customers best advocate 24 hours a day.

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